UNISONIC TECHNOLOGIES CO., LTD

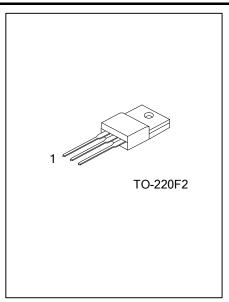
9N90-H **Power MOSFET**

9A, 900V N-CHANNEL **POWER MOSFET**

DESCRIPTION

The UTC 9N90-H is a N-channel mode power MOSFET using UTC's advanced technology to provide customers with planar stripe and DMOS technology. This technology allows a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

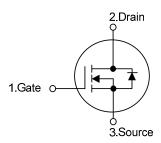
This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.



FEATURES

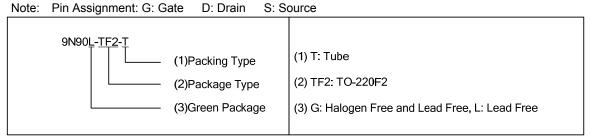
- * $R_{DS(ON)}$ < 1.3 Ω @ V_{GS} =10V, I_{D} =4.5A
- * Fast switching
- * 100% avalanche tested
- * Improved dv/dt capability

SYMBOL



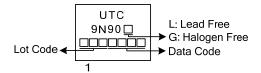
ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
9N90L-TF2-T	9N90G-TF2-T	TO-220F2	G	D	S	Tube	



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■ MARKING



9N90-H Power MOSFET

■ **ABSOLUTE MAXIMUM RATINGS** (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V_{DSS}	900	V	
Gate-Source Voltage		V_{GSS}	±30	V	
Drain Current	Continuous	I_{D}	9	Α	
	Pulsed (Note 2)	I_{DM}	36	Α	
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	1597	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	1.6	V/ns	
Power Dissipation		P_D	58	W	
Junction Temperature		T_J	+150	°C	
Storage Temperature		T_{STG}	-55 ~ + 150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 79mH, I_{AS} = 6.36A, V_{DD} = 50V, R_G = 25 Ω Starting T_J = 25°C
- 4. $I_{SD} \le 9.0A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

PARAMETER	SYMBOL	RATING	UNIT	
Junction to Ambient	θ_{JA}	62.5	°C/W	
Junction to Case	θ_{JC}	2.15	°C/W	

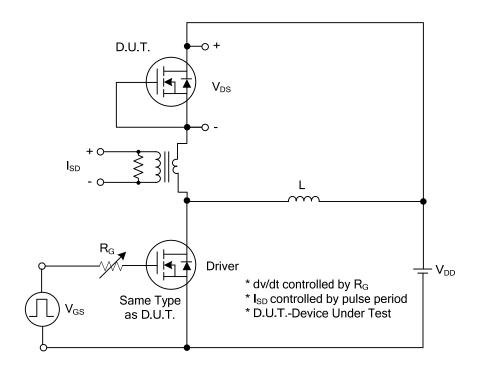
■ ELECTRICAL CHARACTERISTICS(T_J =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	V _{GS} =0V, I _D = 250μA	900			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =900V, V _{GS} =0V			1	μΑ
Gate-Source Leakage Current	Forward	I _{GSS}	V _{GS} =30V, V _{DS} =0V			100	nA
	Reverse		V _{GS} =-30V, V _{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$			4.0	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =4.5A			1.3	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance		C _{ISS}			1912		pF
Output Capacitance		Coss	V _{GS} =0V, V _{DS} =25V, f=1.0 MHz		257		pF
Reverse Transfer Capacitance		C_{RSS}			50		pF
SWITCHING CHARACTERISTICS	3						
Total Gate Charge (Note 1)		Q_G	V _{DS} =180V, V _{GS} =10V, I _D =9.0A,		67.5		nC
Gate to Source Charge		Q _{GS}	I _G =1mA (Note 1, 2)		19		nC
Gate to Drain Charge		Q_{GD}	IG-IIIA (Note 1, 2)		29		nC
Turn-ON Delay Time (Note 1)		$t_{D(ON)}$	V _{DD} =30V, V _{GS} =10V, I _D =9.0A,		37		ns
Rise Time		t_R			97		ns
Turn-OFF Delay Time		$t_{D(OFF)}$	R _G =25Ω (Note 1, 2)		203		ns
Fall-Time		t _F			62		ns
SOURCE- DRAIN DIODE RATING	SS AND CH	ARACTERIS [*]	TICS				
Maximum Body-Diode Continuous Current		I _S				9	Α
Maximum Body-Diode Pulsed Current		I _{SM}				36	Α
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I _S =9.0A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time (Note 1)		t _{rr}	I _S =9.0A, V _{GS} =0V, dI _F /dt =100A/µs		685		ns
Body Diode Reverse Recovery Charge		Q_{rr}			9.36		μC

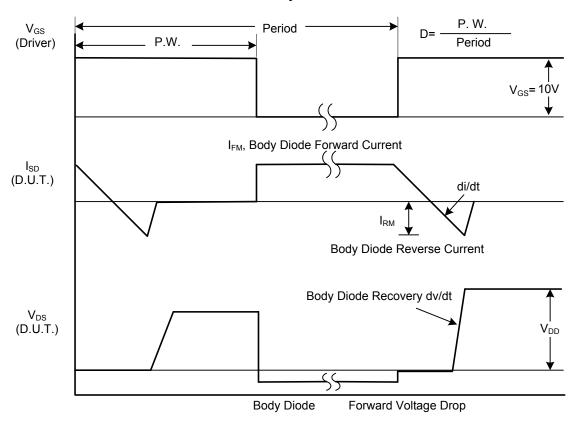
Notes: 1. Pulse Test : Pulse width ≤ 300µs, Duty cycle ≤ 2%.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS



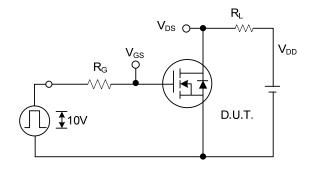
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

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■ TEST CIRCUITS AND WAVEFORMS (Cont.)



V_{DS} 90%

V_{GS} 10%

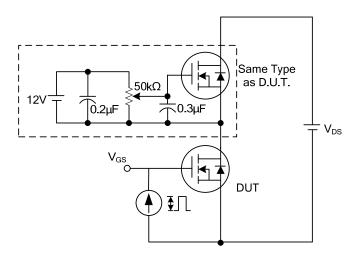
t_{D(ON)}

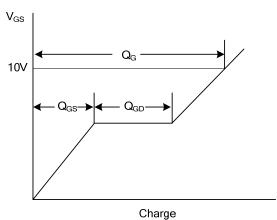
t_R → |

t_R → |

Switching Test Circuit

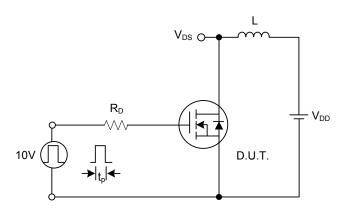
Switching Waveforms

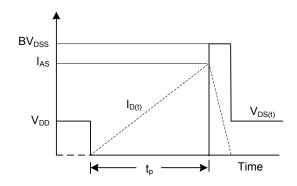




Gate Charge Test Circuit

Gate Charge Waveform



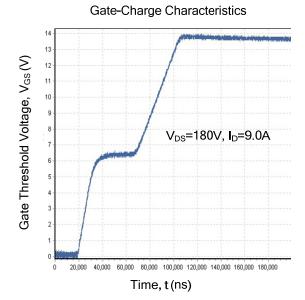


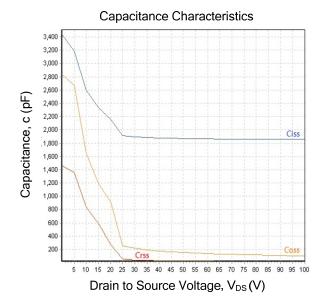
Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms

9N90-H Power MOSFET

■ TYPICAL CHARACTERISTICS





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